

**HEXFET® POWER MOSFET  
THRU-HOLE (TO-257AA)**

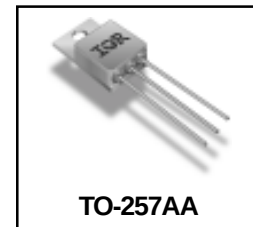
**IRL5Y7413CM  
30V, N-CHANNEL**

**Product Summary**

| Part Number | BV <sub>DSS</sub> | R <sub>DS(on)</sub> | I <sub>D</sub> |
|-------------|-------------------|---------------------|----------------|
| IRL5Y7413CM | 30V               | 0.025Ω              | 18A*           |

Fifth Generation HEXFET® power MOSFETs from International Rectifier utilize advanced processing techniques to achieve the lowest possible on-resistance per silicon unit area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET power MOSFETs are well known for, provides the designer with an extremely efficient device for use in a wide variety of applications.

These devices are well-suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers and high-energy pulse circuits.



**TO-257AA**

**Features:**

- Low R<sub>DS(on)</sub>
- Avalanche Energy Ratings
- Dynamic dv/dt Rating
- Simple Drive Requirements
- Ease of Paralleling
- Hermetically Sealed
- Light Weight

**Absolute Maximum Ratings**

|                                                                | Parameter                       |                                          | Units |
|----------------------------------------------------------------|---------------------------------|------------------------------------------|-------|
| I <sub>D</sub> @ V <sub>GS</sub> = 10V, T <sub>C</sub> = 25°C  | Continuous Drain Current        | 18*                                      | A     |
| I <sub>D</sub> @ V <sub>GS</sub> = 10V, T <sub>C</sub> = 100°C | Continuous Drain Current        | 18*                                      |       |
| I <sub>DM</sub>                                                | Pulsed Drain Current ①          | 72                                       |       |
| P <sub>D</sub> @ T <sub>C</sub> = 25°C                         | Max. Power Dissipation          | 75                                       | W     |
|                                                                | Linear Derating Factor          | 0.6                                      | W/°C  |
| V <sub>GS</sub>                                                | Gate-to-Source Voltage          | ±16                                      | V     |
| E <sub>AS</sub>                                                | Single Pulse Avalanche Energy ② | 230                                      | mJ    |
| I <sub>AR</sub>                                                | Avalanche Current ①             | 18                                       | A     |
| E <sub>AR</sub>                                                | Repetitive Avalanche Energy ①   | 7.5                                      | mJ    |
| dv/dt                                                          | Peak Diode Recovery dv/dt ③     | 2.7                                      | V/ns  |
| T <sub>J</sub>                                                 | Operating Junction              | -55 to 150                               | °C    |
| T <sub>STG</sub>                                               | Storage Temperature Range       |                                          |       |
|                                                                | Lead Temperature                | 300 (0.063in./1.6mm from case for 10sec) |       |
|                                                                | Weight                          | 4.3 (Typical)                            | g     |

\* Current is limited by package

For footnotes refer to the last page

**Electrical Characteristics @ T<sub>j</sub> = 25°C (Unless Otherwise Specified)**

|                                     | Parameter                                    | Min | Typ  | Max            | Units | Test Conditions                                                                                                       |
|-------------------------------------|----------------------------------------------|-----|------|----------------|-------|-----------------------------------------------------------------------------------------------------------------------|
| BV <sub>DSS</sub>                   | Drain-to-Source Breakdown Voltage            | 30  | —    | —              | V     | V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA                                                                          |
| ΔBV <sub>DSS</sub> /ΔT <sub>j</sub> | Temperature Coefficient of Breakdown Voltage | —   | 0.03 | —              | V/°C  | Reference to 25°C, I <sub>D</sub> = 1.0mA                                                                             |
| R <sub>DS(on)</sub>                 | Static Drain-to-Source On-State Resistance   | —   | —    | 0.025<br>0.030 | Ω     | V <sub>GS</sub> = 10V, I <sub>D</sub> = 18A ④<br>V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 18A                         |
| V <sub>GS(th)</sub>                 | Gate Threshold Voltage                       | 1.0 | —    | —              | V     | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA                                                            |
| g <sub>fs</sub>                     | Forward Transconductance                     | 30  | —    | —              | S (r) | V <sub>DS</sub> = 10V, I <sub>DS</sub> = 18A ④                                                                        |
| I <sub>DSS</sub>                    | Zero Gate Voltage Drain Current              | —   | —    | 25<br>250      | μA    | V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V<br>V <sub>DS</sub> = 24V,<br>V <sub>GS</sub> = 0V, T <sub>j</sub> = 125°C |
| I <sub>GSS</sub>                    | Gate-to-Source Leakage Forward               | —   | —    | 100            | nA    | V <sub>GS</sub> = 16V                                                                                                 |
| I <sub>GSS</sub>                    | Gate-to-Source Leakage Reverse               | —   | —    | -100           | nA    | V <sub>GS</sub> = -16V                                                                                                |
| Q <sub>g</sub>                      | Total Gate Charge                            | —   | —    | 79             | nC    | V <sub>GS</sub> = 10V, I <sub>D</sub> = 18A<br>V <sub>DS</sub> = 24V                                                  |
| Q <sub>gs</sub>                     | Gate-to-Source Charge                        | —   | —    | 9.0            | nC    |                                                                                                                       |
| Q <sub>gd</sub>                     | Gate-to-Drain ('Miller') Charge              | —   | —    | 23             | nC    |                                                                                                                       |
| t <sub>d(on)</sub>                  | Turn-On Delay Time                           | —   | —    | 20             | ns    | V <sub>DD</sub> = 15V, I <sub>D</sub> = 18A,<br>V <sub>GS</sub> = 10V, R <sub>G</sub> = 6.2Ω                          |
| t <sub>r</sub>                      | Rise Time                                    | —   | —    | 130            | ns    |                                                                                                                       |
| t <sub>d(off)</sub>                 | Turn-Off Delay Time                          | —   | —    | 52             | ns    |                                                                                                                       |
| t <sub>f</sub>                      | Fall Time                                    | —   | —    | 46             | ns    |                                                                                                                       |
| L <sub>S</sub> + L <sub>D</sub>     | Total Inductance                             | —   | 6.8  | —              | nH    | Measured from drain lead (6mm/<br>0.25in. from package) to source<br>lead (6mm/0.25in. from package)                  |
| C <sub>iss</sub>                    | Input Capacitance                            | —   | 1670 | —              | pF    | V <sub>GS</sub> = 0V, V <sub>DS</sub> = 25V<br>f = 1.0MHz                                                             |
| C <sub>oss</sub>                    | Output Capacitance                           | —   | 660  | —              | pF    |                                                                                                                       |
| C <sub>rss</sub>                    | Reverse Transfer Capacitance                 | —   | 80   | —              | pF    |                                                                                                                       |

**Source-Drain Diode Ratings and Characteristics**

|                 | Parameter                              | Min                                                                                                                  | Typ | Max | Units | Test Conditions                                                     |
|-----------------|----------------------------------------|----------------------------------------------------------------------------------------------------------------------|-----|-----|-------|---------------------------------------------------------------------|
| I <sub>S</sub>  | Continuous Source Current (Body Diode) | —                                                                                                                    | —   | 18* | A     |                                                                     |
| I <sub>SM</sub> | Pulse Source Current (Body Diode) ①    | —                                                                                                                    | —   | 72  | A     |                                                                     |
| V <sub>SD</sub> | Diode Forward Voltage                  | —                                                                                                                    | —   | 1.5 | V     | T <sub>j</sub> = 25°C, I <sub>S</sub> = 18A, V <sub>GS</sub> = 0V ④ |
| t <sub>rr</sub> | Reverse Recovery Time                  | —                                                                                                                    | —   | 110 | ns    | T <sub>j</sub> = 25°C, I <sub>F</sub> = 18A, di/dt ≤ 100A/μs        |
| Q <sub>RR</sub> | Reverse Recovery Charge                | —                                                                                                                    | —   | 300 | nC    | V <sub>DD</sub> ≤ 25V ④                                             |
| t <sub>on</sub> | Forward Turn-On Time                   | Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by L <sub>S</sub> + L <sub>D</sub> . |     |     |       |                                                                     |

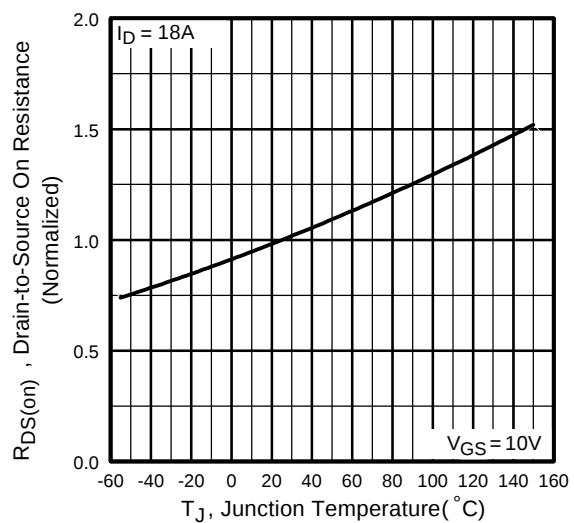
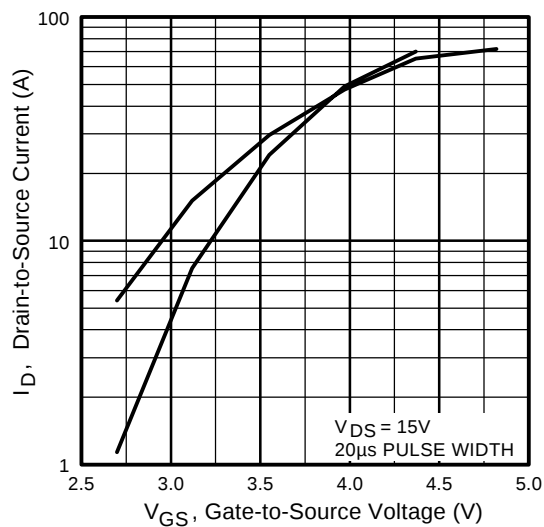
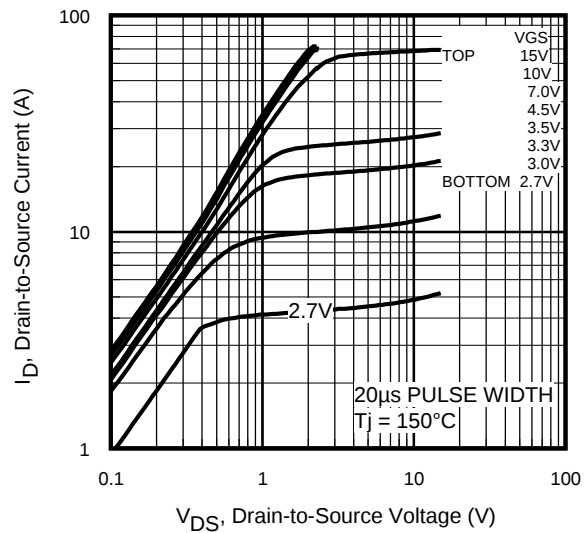
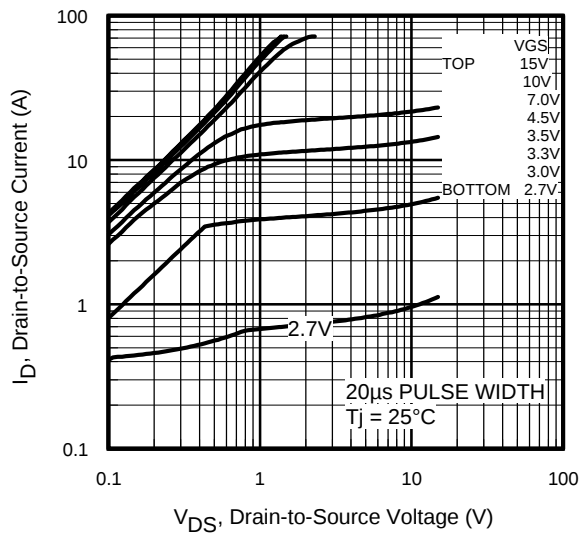
\* Current is limited by package

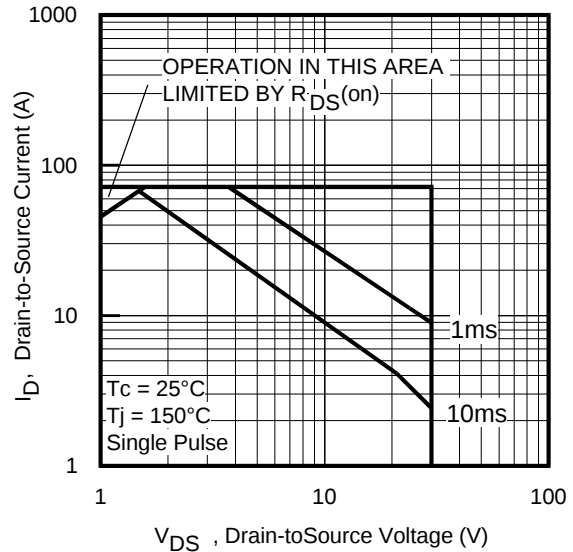
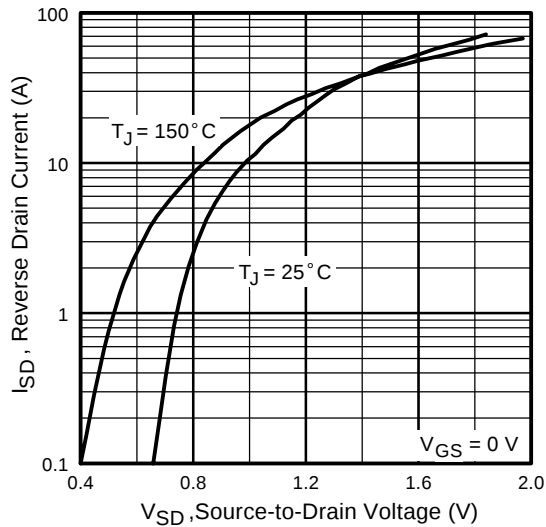
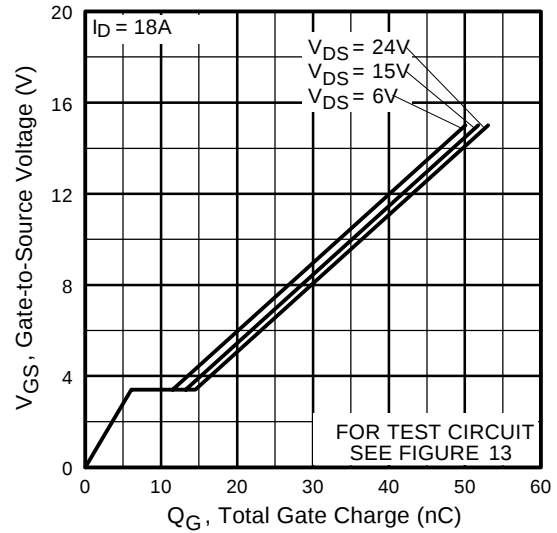
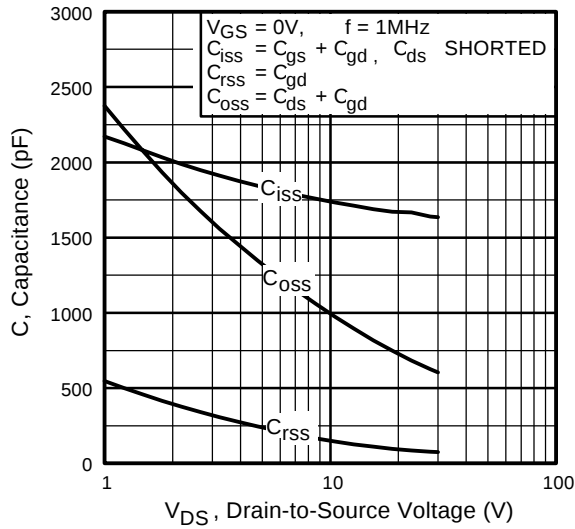
**Thermal Resistance**

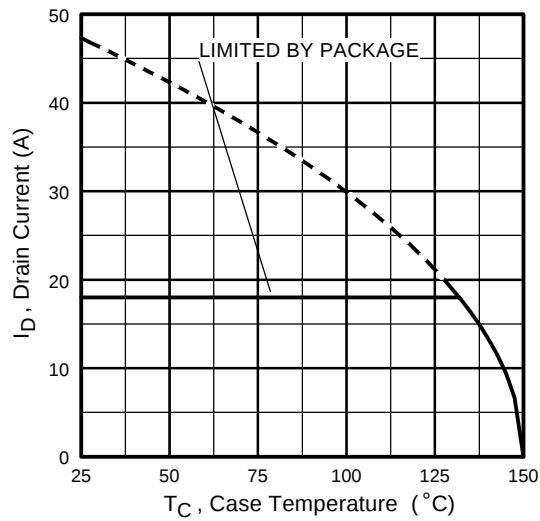
|                   | Parameter        | Min | Typ | Max  | Units | Test Conditions |
|-------------------|------------------|-----|-----|------|-------|-----------------|
| R <sub>thJC</sub> | Junction-to-Case | —   | —   | 1.67 | °C/W  |                 |

Note: Corresponding Spice and Saber models are available on the G&amp;S Website.

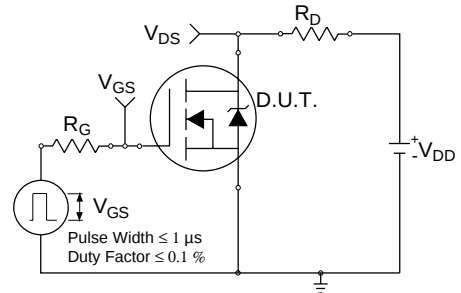
For footnotes refer to the last page



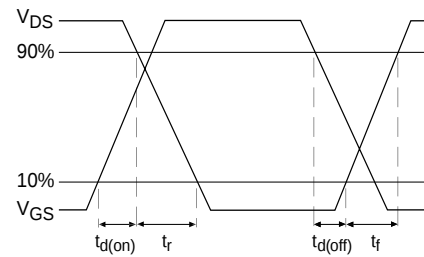




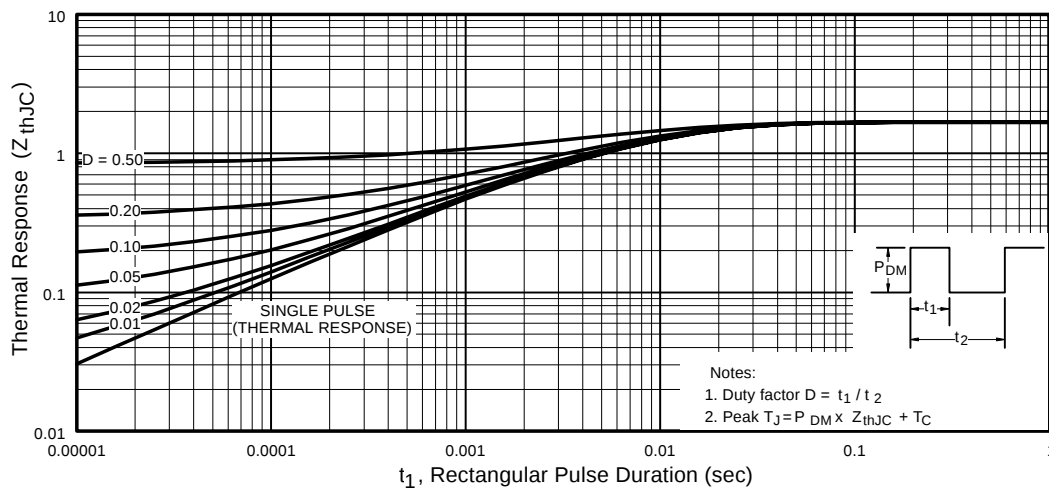
**Fig 9.** Maximum Drain Current Vs. Case Temperature



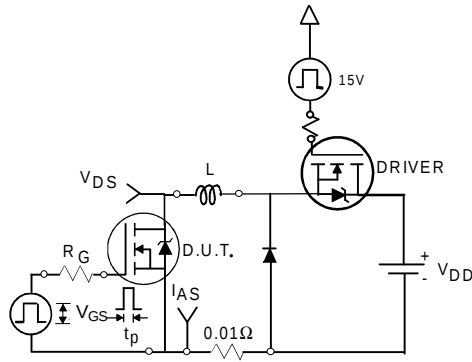
**Fig 10a.** Switching Time Test Circuit



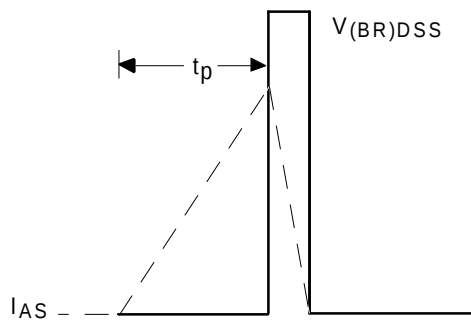
**Fig 10b.** Switching Time Waveforms



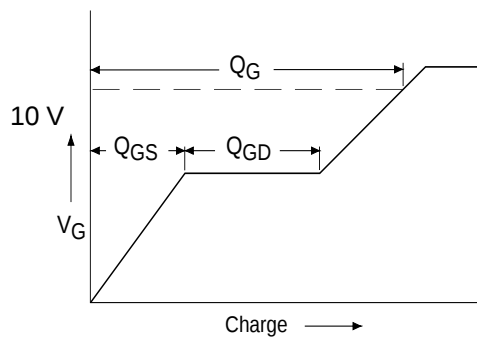
**Fig 11.** Maximum Effective Transient Thermal Impedance, Junction-to-Case



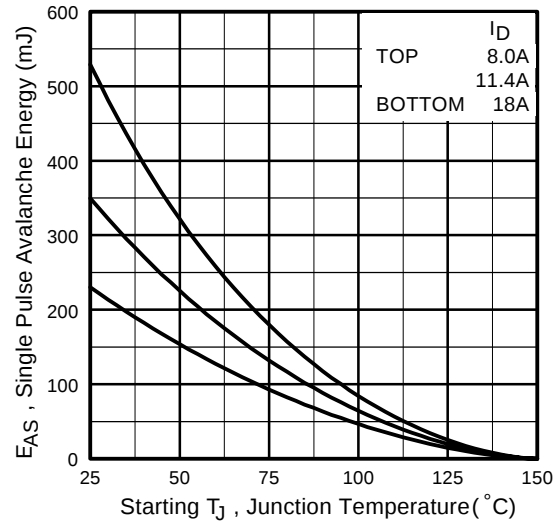
**Fig 12a.** Unclamped Inductive Test Circuit



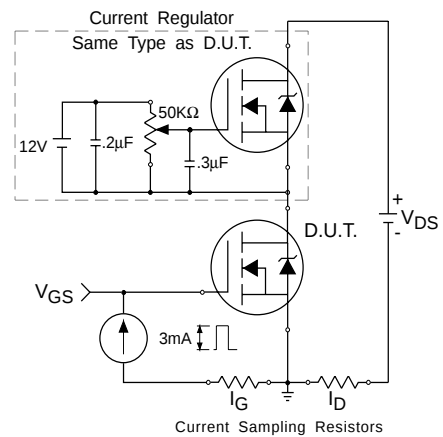
**Fig 12b.** Unclamped Inductive Waveforms



**Fig 13a.** Basic Gate Charge Waveform



**Fig 12c.** Maximum Avalanche Energy Vs. Drain Current

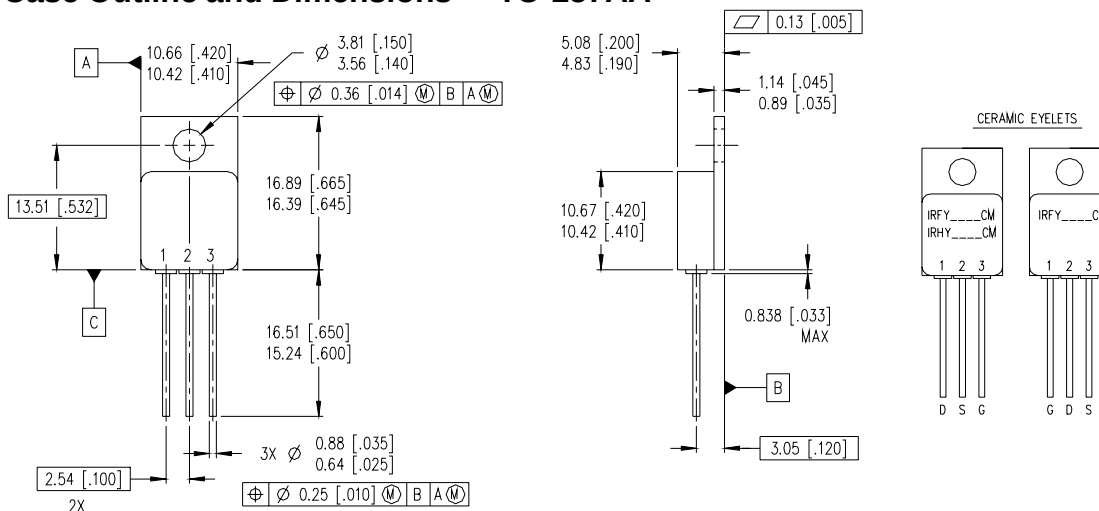


**Fig 13b.** Gate Charge Test Circuit

### Footnotes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- ②  $V_{DD} = 25\text{ V}$ , Starting  $T_J = 25^\circ\text{C}$ ,  $L = 1.4\text{ mH}$   
Peak  $I_{AS} = 18\text{ A}$ ,  $V_{GS} = 10\text{ V}$ ,  $R_G = 25\Omega$
- ③  $I_{SD} \leq 18\text{ A}$ ,  $di/dt \leq 140\text{ A}/\mu\text{s}$ ,  
 $V_{DD} \leq 30\text{ V}$ ,  $T_J \leq 150^\circ\text{C}$
- ④ Pulse width  $\leq 300\text{ }\mu\text{s}$ ; Duty Cycle  $\leq 2\%$

### Case Outline and Dimensions — TO-257AA



### NOTES:

1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1994.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
4. OUTLINE CONFORMS TO JEDEC OUTLINE TO-257AA.

### LEGEND

D - DRAIN  
S - SOURCE  
G - GATE